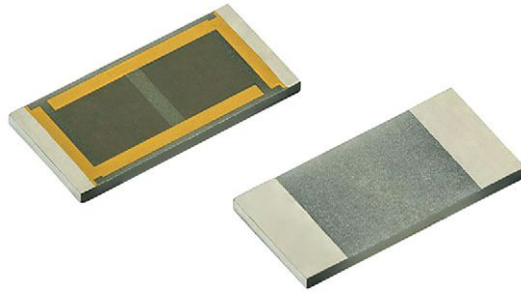


High Power Aluminum Nitride, Wraparound Surface Mount, Precision Thin Film Chip Resistor (up to 6 W)



PCAN series chip resistors are designed on aluminum nitride ceramic substrates with enlarged backside terminations to reduce the thermal resistance between the topside resistor layer and the solder joint on the end users circuit assembly.

Actual power handling capability is limited by the end user mounting process. As with any high power chip resistor the ability to remove the heat is critical to the overall performance of the device.

FEATURES

- High thermal conductivity aluminum nitride substrate
- Power rating up to 6.0 W
- Resistance range 2 Ω to 30.1 kΩ
- Resistor tolerance to ± 0.1 %
- TCR to ± 25 ppm/°C
- Flame resistant UL 94 V-0
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



Available
RoHS*
 Available
HALOGEN FREE
GREEN
 (5-2008)
 Available

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

APPLICATIONS

- Power supplies
- Power switching
- Braking system

TYPICAL PERFORMANCE

| | ABSOLUTE |
|------|----------|
| TCR | 25 |
| TOL. | 0.1 |

| STANDARD ELECTRICAL SPECIFICATIONS | | |
|------------------------------------|---------------------------------------|-------------------|
| TEST | SPECIFICATIONS | CONDITIONS |
| Material | Passivated nichrome | - |
| Resistance Range | 2 Ω to 30.1 kΩ | - |
| TCR: Absolute | 25 ppm/°C (standard) and 100 ppm/°C | - |
| Tolerance: Absolute | 0.1 %, 0.25 %, 0.5 %, 1.0 % and 5.0 % | -55 °C to +150 °C |
| Power Rating: Resistor | 0.5 W to 6.0 W ⁽¹⁾ | Maximum at +70 °C |
| Stability: Absolute | ΔR 1.0 % | 1000 h at +70 °C |
| Voltage Coefficient | < 0.1 ppm/V | - |
| Working Voltage | 75 V to 200 V | - |
| Operating Temperature Range | -55 °C to +155 °C | - |
| Storage Temperature Range | -55 °C to +155 °C | - |
| Noise | < -30 dB | - |
| Shelf Life Stability: Absolute | ± 0.01 % | 1 year at +25 °C |

Note

⁽¹⁾ Dependant on component mounting by user.

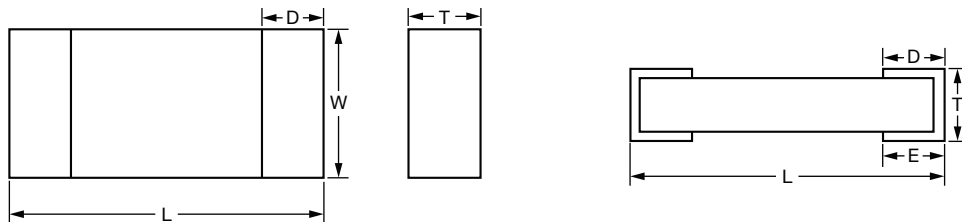
| COMPONENT RATINGS | | | |
|-------------------|---------------------|---------------------|----------------------|
| CASE SIZE | POWER RATING (mW) | WORKING VOLTAGE (V) | RESISTANCE RANGE (Ω) |
| 0603 | 500 ⁽²⁾ | 75 | 2 to 30.1K |
| 0805 | 1000 ⁽²⁾ | 100 | 2 to 30.1K |
| 1206 | 2000 ⁽²⁾ | 200 | 2 to 30.1K |
| 2512 | 6000 ⁽²⁾ | 200 | 2 to 30.1K |

Note

⁽²⁾ Dependant on component mounting by user.

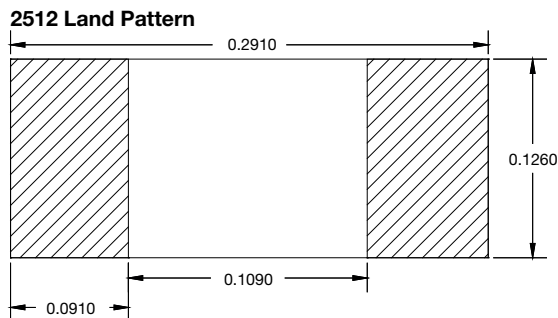
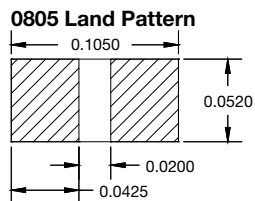
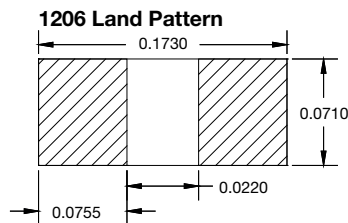
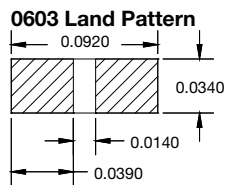
| ENVIRONMENTAL TESTS | | |
|-----------------------------------------------|-----------------------------------------|----------------------------|
| ENVIRONMENTAL TEST | LIMITS MIL-PRF-55342 CHARACTERISTIC "H" | TYPICAL VISHAY PERFORMANCE |
| Resistance temperature characteristic | ± 50 ppm/°C | ± 25 ppm/°C |
| Maximum ambient temperature at rated wattage | +70 °C | +70 °C |
| Maximum ambient temperature at power derating | +150 °C | +150 °C |
| Thermal shock | ± 0.25 % | ± 0.10 % |
| Low temperature operation | ± 0.25 % | ± 0.10 % |
| Short time overload | ± 0.1 % | ± 0.10 % |
| High temperature exposure | ± 0.2 % | ± 0.10 % |
| Resistance to soldering heat | ± 0.25 % | ± 0.10 % |
| Moisture resistance | ± 0.4 % | ± 0.50 % |
| Life at +70 °C for 1000 h | ± 0.5 % | ± 1.00 % |

DIMENSIONS in inches



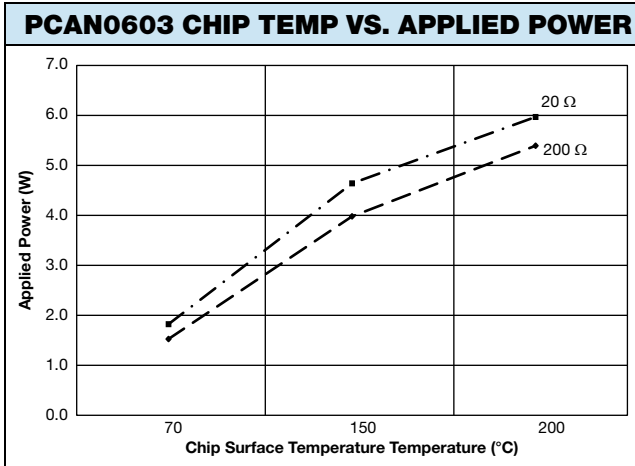
| CASE SIZE | LENGTH L | WIDTH W | THICKNESS T MIN./MAX. | TOP PAD D | BOTTOM PAD E |
|-----------|-------------------------|---------------|-----------------------|-------------------------|---------------|
| 0603 | 0.064 ± 0.006 | 0.032 ± 0.005 | 0.015 ± 0.003 | 0.012 ± 0.005 | 0.021 ± 0.005 |
| 0805 | 0.080 ± 0.006 | 0.050 ± 0.005 | 0.015 ± 0.003 | 0.016 ± 0.005 | 0.025 ± 0.005 |
| 1206 | 0.126 ± 0.008 | 0.063 ± 0.005 | 0.015 ± 0.003 | 0.020 + 0.005 / - 0.010 | 0.040 ± 0.005 |
| 2512 | 0.259 + 0.009 / - 0.015 | 0.124 ± 0.005 | 0.015 ± 0.003 | 0.020 ± 0.005 | 0.050 ± 0.005 |

LAND PATTERN DIMENSIONS in inches

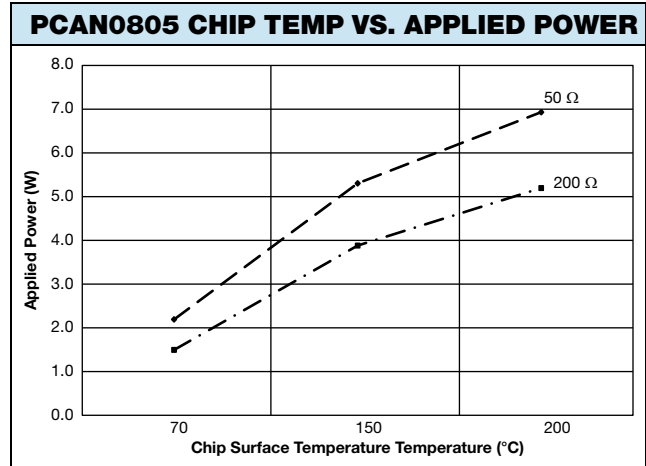




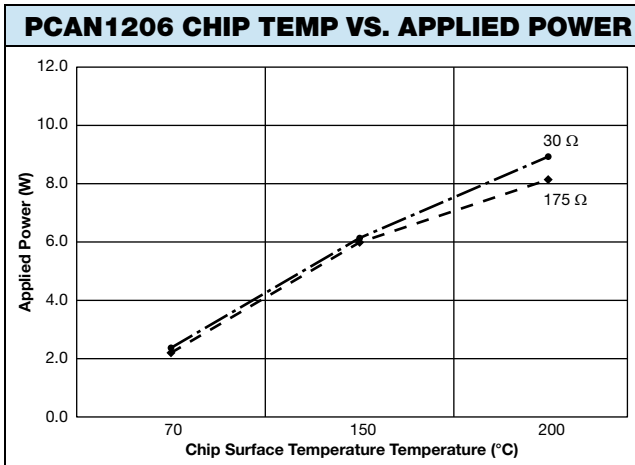
| STANDARD MATERIAL SPECIFICATIONS | |
|----------------------------------|-------------------------------------------------------------------|
| Resistive element | Passivated nichrome |
| Substrate material | Aluminum nitride |
| Terminations (Tin/lead) | Tin/lead solder over nickel barrier |
| Terminations (Lead (Pb)-free) | Tin/silver/copper (Sn96.5/Ag3.0/Cu0.5) solder over nickel barrier |



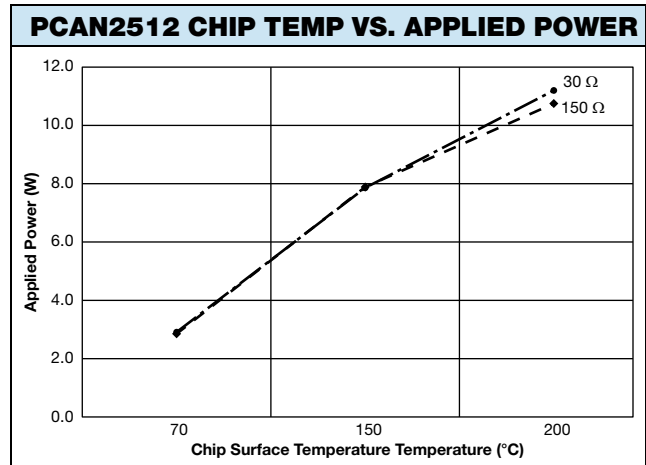
- Note**
- Chip surface temperature measured using FLIR SC645 thermal imaging system with an approximate testcard surface temperature of 75 °C.



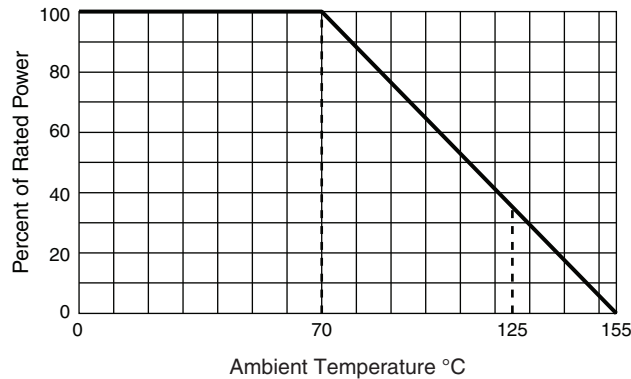
- Note**
- Chip surface temperature measured using FLIR SC645 thermal imaging system with an approximate testcard surface temperature of 75 °C.



- Note**
- Chip surface temperature measured using FLIR SC645 thermal imaging system with an approximate test card surface temperature of 85 °C.
 - Thermal imaging was conducted under ambient conditions resulting in a steady state test card surface temperature of 85 °C over the full range of power levels.
 - Thermal imaging and load life testing was conducted mounting one device to a 1.6" x 3.7" test card with 3.5 mil copper plating on both surfaces. Thermal vias on 50 mil centers were utilized for heat transfer between surfaces of the test card.



- Note**
- Chip surface temperature measured using FLIR SC645 thermal imaging system with an approximate test card surface temperature of 85 °C.

DERATING CURVE

GLOBAL PART NUMBER INFORMATION

 New Global Part Numbering: **PCAN1206H1000BBT1**

| | | | | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| P | C | A | N | 1 | 2 | 0 | 6 | H | 1 | 0 | 0 | 0 | B | B | T | 1 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|

| GLOBAL MODEL | CASE SIZE | TCR CHARACTERISTIC | RESISTANCE | TOLERANCE | TERMINATION | PACKAGING |
|--------------|------------------------------|-----------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PCAN | 0603 0805 1206 2512 | E = ± 25 ppm/°C H = ± 50 ppm/°C K = ± 100 ppm/°C ⁽¹⁾ | The first 3 digits are significant figures and the last digit specifies the number of zeros to follow. "R" designates the decimal point. Example: 10R0 = 10 Ω 1000 = 100 Ω | B = ± 0.1 % ⁽²⁾ C = ± 0.25 % D = ± 0.5 % F = ± 1.0 % ⁽¹⁾ G = ± 2.0 % | B = Wraparound Sn/Pb solder w/ nickel barrier S = Wraparound lead (Pb)-free solder (e1) RoHS compliant G = Wraparound Au, over Ni (gold) termination epoxy bondable RoHS compliant (e4) | BS = BULK 100 min., 1 mult WS = WAFFLE 100 min., 1 mult W0 = 100 pc min. waffle, 1 mult W1 = 100 min., 1 mult (package unit single lot date code) TAPE AND REEL T0 = 100 min., 100 mult T1 = 1000 min., 1000 mult T3 = 300 min., 300 mult T5 = 500 min., 500 mult TF = Full reel TS = 100 min., 1 mult TI = 100 min., 1 mult (item single lot date code) TP = 100 min., 1 mult (package unit single lot date code) |

Notes

- (1) Less than 10 Ω. 100 ppm/°C and 1 % tolerance best.
 (2) Available on 10 Ω and higher.



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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.